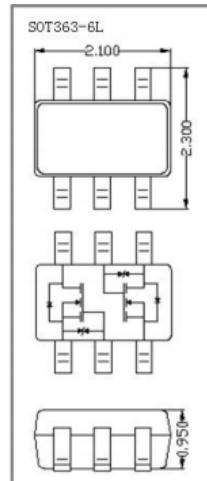


## N-Channel MOSFET

- ◇ Epoxy meets UL 94 V-0 flammability rating
- ◇ High density cell design for low  $R_{DS(ON)}$
- ◇ Voltage controlled small signal switch
- ◇ High Saturation Current Capability
- ◇ ESD Protected



Device Marking Code	
2N7002KDW	K27

Circuit and Pin Schematic

### Maximum Ratings ( $T_a = 25^\circ\text{C}$ )

Symbol	Parameter	Value	Units
$V_{DS}$	Drain-source Voltage	60	V
$V_{GS}$	Gate-source-Voltage	$\pm 20$	V
$I_D$	Drain Current	340	mA
$P_d$	Total Power Dissipation	150.	mW
$T_J$	Junction Temperature	150	$^\circ\text{C}$
$T_{STG.}$	Storage Temperature	-55 to 150	$^\circ\text{C}$
$R_{\theta JA}$	Thermal Resistance from Junction to Ambient	820	$^\circ\text{C}/\text{W}$

### ELECTRICAL CHARACTERISTICS ( $T_a = 25^\circ\text{C}$ )

Symbol	Parameter	Conditions	Min	Typ	Max	Units
$V_{(BR)Dss}$	Drain-source Breakdown Voltage	$V_{GS} = 0\text{V}, I_D = 250\ \mu\text{A}$	60			V
$V_{GS(th)}$	Gate-Threshold Voltage (note 1)	$V_{DS}=V_{GS}, I_D = 1\text{mA}$	1.0		2.5	V
$I_{GSS}$	Gate-body Leakage	$V_{DS}=0\text{V}, V_{GS} = \pm 20\text{V}$			$\pm 10$	$\mu\text{A}$
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=48\text{V}, V_{GS}=0\text{V}$			1	$\mu\text{A}$
$R_{dson}$	Drain-source On-resistance (note 1)	$V_{GS}=4.5\text{V}, I_D=200\text{mA}$ $V_{GS}=10\text{V}, I_D=500\text{mA}$			5.3 5.0	$\Omega$
$V_{sd}$	Diode Forward Voltage (note 1)	$V_{GS}=0\text{V}, I_S = 300\text{mA}$			1.5	V
$Q_r$	Recovered charge	$V_{GS}=0\text{V}, I_S = 300\text{mA}$ $V_R=25\text{V}, dI_s/dt=-100\text{A}/\mu\text{s}$		30		nC

**Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =10V V <sub>GS</sub> =0V F=1MHz			40	pF
C <sub>oss</sub>	Output Capacitance				30	
C <sub>rss</sub>	Reverse Transfer Capacitance				10	

**Switching Characteristics**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
T <sub>d(on)</sub>	Turn on delay time	V <sub>DD</sub> =50V, V <sub>GS</sub> =10V, R <sub>L</sub> =250Ω R <sub>GS</sub> =50Ω, R <sub>GEN</sub> =50Ω			10	ns
T <sub>d(off)</sub>	Turn off delay time				15	
t <sub>rr</sub>	Reverse recovery time		V <sub>GS</sub> =0V, I <sub>S</sub> =300mA, V <sub>R</sub> =25V dI <sub>S</sub> /dt=-100A/us		30	

**Gate – Source Zener Diode**

BV <sub>GSO</sub>	Gate–Source Breakdown Voltage	I <sub>GS</sub> =±1mA(Open Drain)	±21.5		±30	V
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**Note:**

1. Pulse Test : Pulse width  $\leqslant 300\mu\text{s}$ , duty cycle  $\leqslant 2\%$ .

## Package Dimensions

